

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE30H11BK uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

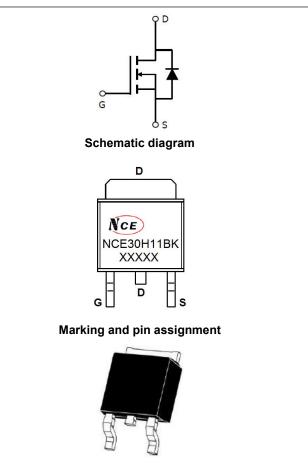
General Features

- V_{DS} =30V,I_D =110A
 R_{DS(ON)} =2.7mΩ (typical) @ V_{GS}=10V
 R_{DS(ON)} =3.9mΩ (typical) @ V_{GS}=4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- DC/DC converters
- Synchronous Rectifier

100% UIS TESTED!



TO-252-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE30H11BK	NCE30H11BK	TO-252-2L	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	110	A
Drain Current-Continuous(T _C =100 ℃)	l _D (100℃)	77.8	A
Pulsed Drain Current	I _{DM}	440	A
Maximum Power Dissipation	Р	115	W
Derating factor		0.77	W/℃
Single pulse avalanche energy ^(Note 5)	E _{AS}	300	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{ejc}	1.36	°C/W]
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Electrical Characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			-			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30	-	-	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
On Characteristics (Note 3)	I					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1	1.5	2.2	V
	5	V_{GS} =10V, I _D =20A	-	2.7	3.2	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A		3.9	5.2	
Forward Transconductance	g Fs	V _{DS} =5V,I _D =20A	20	-	-	S
Dynamic Characteristics (Note4)	I					
Input Capacitance	Clss		-	3009	-	PF
Output Capacitance	Coss	V _{DS} =15V,V _{GS} =0V, - 451	451	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz		403	-	PF
Switching Characteristics (Note 4)	· · ·		•			
Turn-on Delay Time	t _{d(on)}		-	11	-	nS
Turn-on Rise Time	tr	V _{DD} =15V,I _D =20A	-	14	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _{GEN} =3Ω - 36	-	nS		
Turn-Off Fall Time	t _f		-	12	-	nS
Total Gate Charge	Qg		-	66.3	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =15V,I _D =20A, - 7.0	-	nC		
Gate-Drain Charge	Q _{gd}	- V _{GS} =10V - 17.2		-	nC	
Drain-Source Diode Characteristics	I		·			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	ls		-	-	110	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 20A	-	29	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	32	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

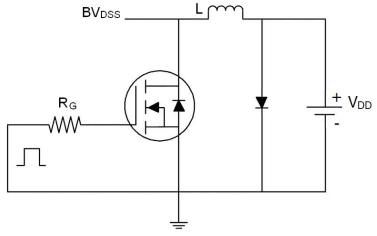
4. Guaranteed by design, not subject to production

5. EAS condition: $Tj=25^{\circ}C$, $V_{DD}=15V$, $V_{G}=10V$, L=0.5mH, $Rg=25\Omega$;

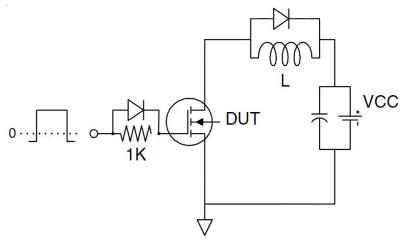


Test Circuit

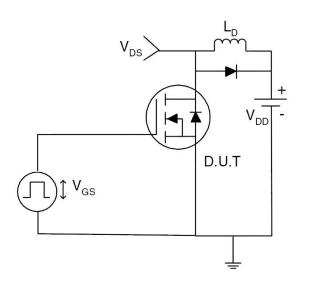
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

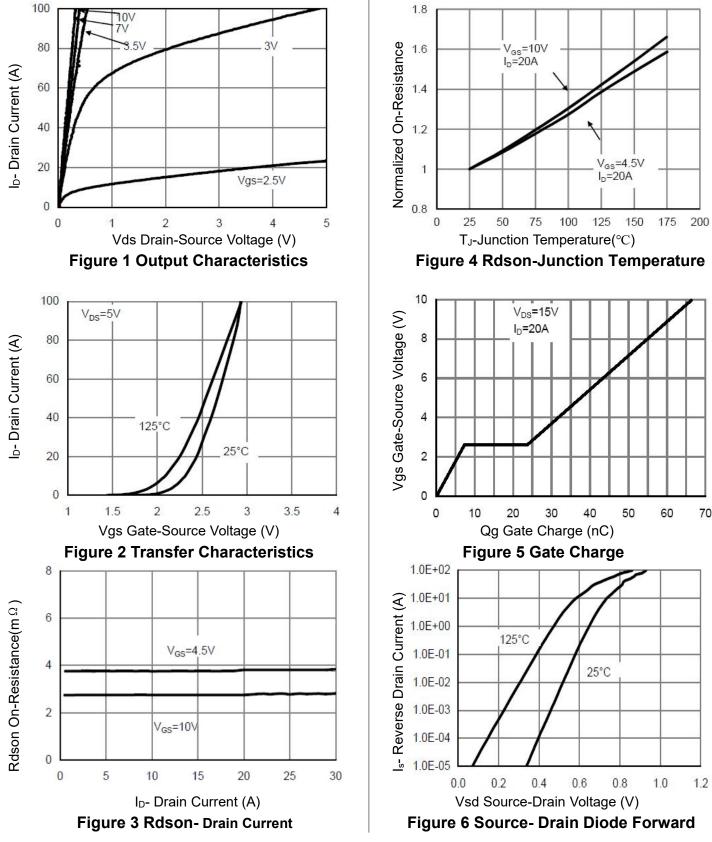


3) Switch Time Test Circuit





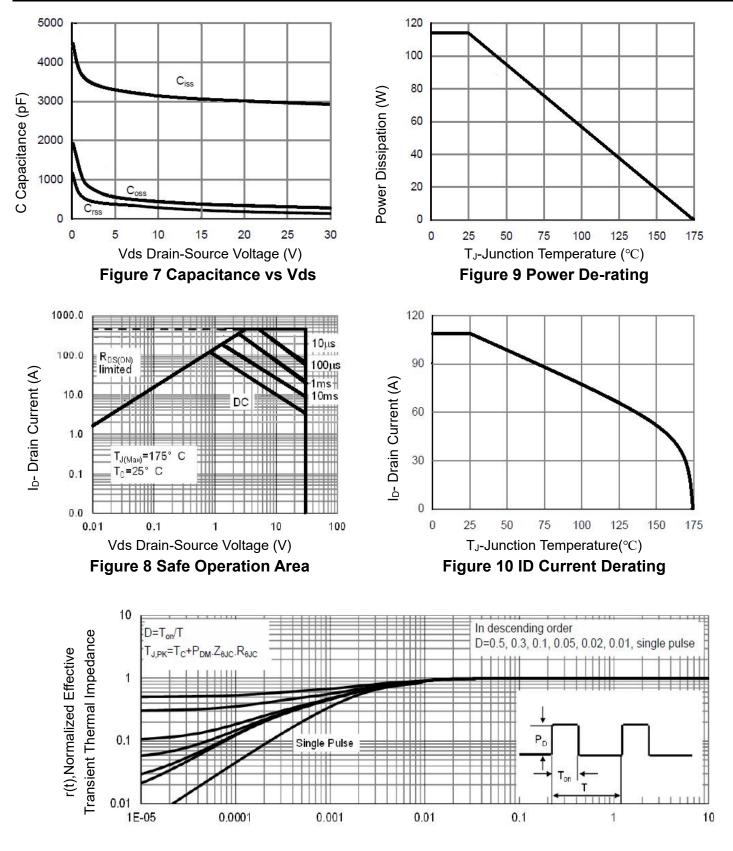






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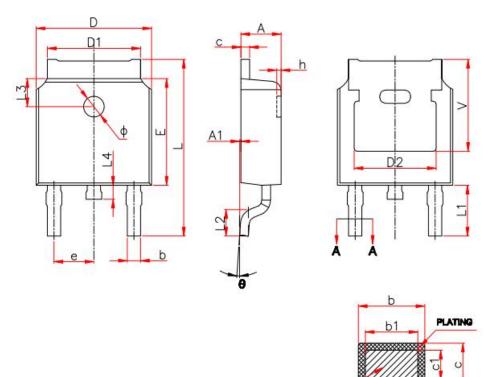
NCE30H11BK



Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



BASE METAL

SECTION A-A

Cumbal	Millimeters		
Symbol -	Min.	Max.	
A	2.20	2.40	
A1	0.00 0.1		
b	0.66	0.86	
b1	0.73	0.79	
С	0.46	0.58	
c1	0.50	0.52	
D	6.50	6.70	
D1	5.10	5.46	
D2	4.83 REF.		
E	6.00	6.20	
е	2.19	2.39	
L	9.80	10.40	
L1	2.90 REF.		
L2	1.40	1.70	
L3	1.60 REF.		
L4	0.60	1.00	
Φ	1.10	1.30	
θ	0°	8°	



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